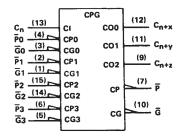
Directly Compatible for Use With: SN54LS181/SN74LS181, SN54S281/SN74S281, SN54S381, SN74S381, SN54S481/SN74S481

PIN DESIGNATIONS

ALTERNATIVE	DESIGNATIONS†	PIN NOS.	FUNCTION
G 0, G 1, G 2, G 3	G0, G1, G2, G3	3, 1, 14, 5	CARRY GENERATE INPUTS
PO, P1, P2, P3	P0, P1, P2, P3	4, 2, 15, 6	CARRY PROPAGATE INPUTS
Cn	¯C _n	13	CARRY INPUT
C _{n+x} , C _{n+y} , C _{n+z}	$\overline{C}_{n+x}, \overline{C}_{n+y}, \overline{C}_{n+z}$	12, 11, 9	CARRY OUTPUTS
Ğ	Y	10	CARRY GENERATE OUTPUT
P	×	7	CARRY PROPAGATE OUTPUT
V	'cc	16	SUPPLY VOLTAGE
G	ND	8	GROUND

 $^{^{\}dagger} \text{Interpretations}$ are illustrated in the 'LS181, 'S181 data sheet.

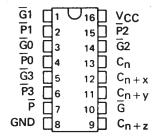
logic symbol‡



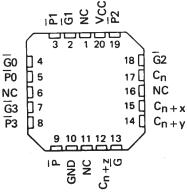
[‡]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

SN54S182 . . . J OR W PACKAGE SN74S182 . . . D OR N PACKAGE (TOP VIEW)



SN54S182 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

description

The SN54S182 and SN74S182 are high-speed, look-ahead carry generators capable of anticipating a carry across four binary adders or group of adders. They are cascadable to perform full look-ahead across n-bit adders. Carry, generate-carry, and propagate-carry functions are provided as enumerated in the pin designation table above.

When used in conjunction with the 'LS181 or 'S181 arithmetic logic unit (ALU), these generators provide high-speed carry look-ahead capability for any word length. Each 'S182 generates the look-ahead (anticipated carry) across a group of four ALUs and, in addition, other carry look-ahead circuits may be employed to anticipate carry across sections of four look-ahead packages up to n-bits. The method of cascading 'S182 circuits to perform multilevel look-ahead is illustrated under typical application data.

The carry functions (inputs, outputs, generate, and propagate) of the look-ahead generators are implemented in the compatible forms for direct connection to the ALU. Reinterpretations of carry functions as explained on the 'LS181 and 'S181 data sheet are also applicable to and compatible with the look-ahead generator. Logic equations for the 'S182 are:

$$\begin{array}{lll} C_{n+x} = G0 + P0 \ C_{n} & \overline{C}_{n+x} = \overline{Y0 \ (X0 + C_{n})} \\ C_{n+y} = G1 + P1 \ G0 + P1 \ P0 \ C_{n} & \overline{C}_{n+y} = \overline{Y1 \ [X1 + Y0 \ (X0 + C_{n})]} \\ C_{n+z} = G2 + P2 \ G1 + P2 \ P1 \ G0 + P2 \ P1 \ P0 \ C_{n} & \overline{C}_{n+z} = \overline{Y2 \ (X2 + Y1 \ [X1 + Y0 \ (X0 + C_{n})])} \\ \overline{C}_{n+z} = \overline{Y3 \ (X3 + Y2) \ (X3 + X2 + Y1) \ (X3 + X2 + X1 + Y0)} \\ \overline{C}_{n+z} = \overline{Y3 \ (X3 + Y2) \ (X3 + X2 + Y1) \ (X3 + X2 + X1 + Y0)} \\ X = X3 + X2 + X1 + X0 & \overline{C}_{n+z} = \overline{Y0 \ (X0 + C_{n})} \\ \overline{C}_{n$$



FUNCTION TABLE FOR G OUTPUT

		OUTPUT					
G3	G2	Ğ					
L	Х	Х	Х	X	X	X	L
х	L	X	X	L	X	X	L
х	X	L	Х	L	L	X	L
×	Х	X	L	L	L	L	L
	All	othe	r comi	binati	ions		н

FUNCTION TABLE FOR \overline{P} OUTPUT

	INP	OUTPUT				
P3	P2	Ē1	P ₀	P		
L	L,	L	L	L		
	All d	othei	•	н		
co	mbi	natio	ons	l		

FUNCTION TABLE FOR C_{n+x} OUTPUT

H	NPUT	OUTPUT	
Ğ0	ΡO	C _{n+x}	
L	Х	Х	Н
х	L	Н	н
A	II oth	er	1
com	binati	ions	-

FUNCTION TABLE FOR C_{n+y} OUTPUT

	iN		OUTPUT		
G1	G0	Cn	C _{n+y}		
L	X	Х	X	X	Н
Х	L	L	Х	X	н
х	Х	L	L	Н	н
	Al	L			
l	comi	binat	tions		

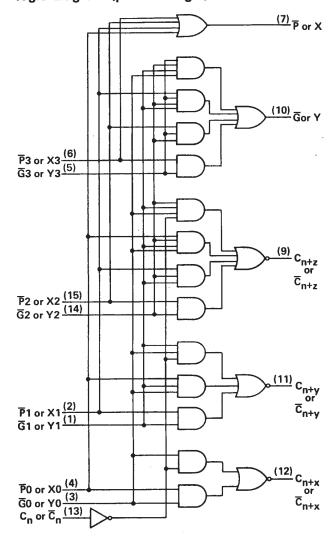
FUNCTION TABLE FOR Cn+z OUTPUT

			OUTPUT				
Ğ2	Ğ1	Ğ0	Cn	C _{n+z}			
L	X	Х	Х	Х	Х	X	н
×	L	X	L	X	X	X	н
×	X	L	L	L	X	X	н
х	X	X	L	L	L	Н	н
	All	other	coml	oinati	ons		L

H = high level, L = low level, X = irrelevant

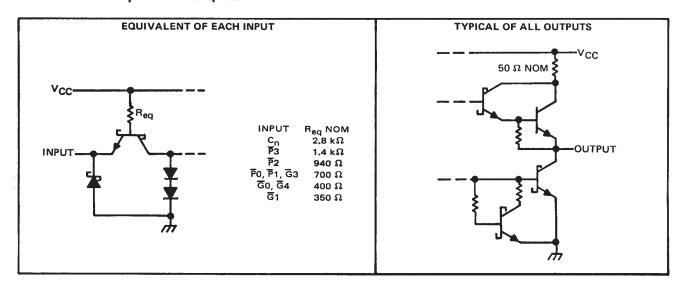
Any inputs not shown in a given table are irrelevant with respect to that output.

logic diagram (positive logic)



Pin numbers shown are for D, J, N, and W packages.

schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	7 V
Input voltage	.5 V
Interemitter voltage (see Note 2) 5	.5 V
Operating free-air temperature range: SN54S18255°C to 12	5°C
SN74S182 0 °C to 7	0°C
Storage temperature range65°C to 15	0°C

NOTES: 1. Voltage values, except interemitter voltage, are with respect to network ground terminal.

2. This is the voltage between two emitters of a multiple-emitter input transistor. For these circuits, this rating applies to each \overline{G} input in conjunction with any other \overline{G} input or in conjunction with any \overline{P} input.

recommended operating conditions

	S	SN54S182			SN74S182			
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	V	
High-level output current, IOH			-1			-1	mA	
Low-level output current, IOL			20			20	mA	
Operating free-air temperature, TA	-55		125	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CO	NDITIONS†	S	N54S18	32	S	N74S18	32	UNIT	
	PANAME	IEN	I EST CO	MDITIONS.	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage	je			2			2	•		V
ViL	Low-level input voltage	je					0.8			0.8	V
VIK	Input clamp voltage		V _{CC} = MIN,	I _I = -18 mA			-1.2			-1.2	V
VOH High-level output voltage			V _{CC} = MIN, V _{IL} = 0.8 V,	V _{IH} = 2 V, I _{OH} = -1 mA	2.5	3.4		2.7	3.4		٧
VOL	Low-level output volt	age	V _{CC} = MIN, V _{IL} = 0.8 V,	V _{IH} = 2 V, I _{OL} = 20 mA			0.5			0.5	٧
11	Input current at maxi	mum input voltage	V _{CC} = MAX,	V _I = 5.5 V			1			1	mA
		C _n input					50			50]
	:	P3 input]				100			100	
1	High-level	P2 input	VasaMAY	, V ₁ = 2.7 V			150			150	
ΉН	input current	PO, P1, or G3 input	CC - MAA,				200			200	μΑ
		G0 or G2 input					350			350	
		G1 input					400			400	7
		C _n input					-2			-2	
		P3 input	1				-4			-4	
1	Low-level	P2 input],,,,,,,,,,	V: - 0 E V			6			-6]^
ΙįΣ	input current	PO, P1, or G3 input	V _{CC} = MAX,	V ~ 0.5 V			-8			-8	mA
		GO or G2 input]				-14			-14	1
		G1 input					-16			-16	
IOS Short-circuit output current§		V _{CC} = MAX		-40		-100	-40		-100	mA	
ICCH Supply current, all outputs high		V _{CC} = 5 V,	See Note 3		35	65		35	70	mA	
CCL	Supply current, all ou	tputs low	V _{CC} = MAX,	See Note 4		69	99		69	109	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ} \text{C}$

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS		MAX	UNIT
tPLH	Go, G1, G2, G3,	C _{n+x} , C _{n+y} ,		4.5	7	ns
tPHL	P0, P1, P2, or P3	or C _{n+z}		4.5	7] '''
tPLH t	G0, G1, G2, G3,	G		5	7.5	ns
tPHL.	P1, P2, or P3	. .	$R_L = 280 \Omega$, $C_L = 15 pF$,	7	10.5	113
tPLH	P0, P1, P2, or P3	P	See Note 5	4.5	6.5	ns
tPHL	10,11,12,0113	•		6.5	10	
^t PLH	- C _n	C _{n+x} , C _{n+y} , or C _{n+z}		6.5	10	ns
tPH L	on .	or C _{n+z}		7	10.5	115

NOTE 5: Load circuits and voltage waveforms are shown in Section 1.



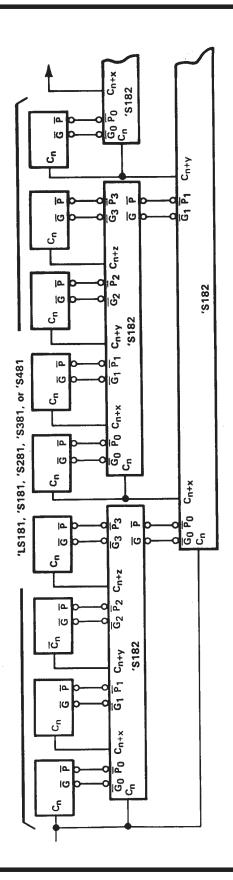
[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25 ^{\circ}\text{C}$.

[§] Not more than one output should be shorted at a time and duration of the short-circuit test should not exceed one second.

NOTES: 3. ICCH is measured with all outputs open, inputs \$\overline{P}\$3 and \$\overline{G}\$3 at 4.5 V, and all other inputs grounded. MAX is determined at 5.5 V.

^{4.} ICCL is measured with all outputs open; inputs \$\overline{G0}\$, \$\overline{G1}\$, and \$\overline{G2}\$ at 4.5 V; and all other inputs grounded.

TYPICAL APPLICATION DATA



64-BIT ALU, FULL-CARRY LOOK-AHEAD IN THREE LEVELS

Remaining inputs and outputs of 'LS181, 'S181, 'S281, 'S381, and 'S481 are not shown.

www.ti.com 1-Jul-2023

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
JM38510/07802BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07802BEA	Samples
M38510/07802BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07802BEA	Samples
SN54S182J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S182J	Samples
SNJ54S182FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S 182FK	Samples
SNJ54S182J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S182J	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



PACKAGE OPTION ADDENDUM

www.ti.com 1-Jul-2023

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

PACKAGE MATERIALS INFORMATION

www.ti.com 5-Jan-2022

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SNJ54S182FK	FK	LCCC	20	1	506.98	12.06	2030	NA

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



14 LEADS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2023, Texas Instruments Incorporated